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Information technology – AT attachment with packet interface-7 – Part 3: Serial transport protocols and physical interconnect (ATA/ATAPI-7 V3)

CONTENTS

FOREWORD 12
INTRODUCTION 13
1 Scope 14
2 Normative references 14
3 Terms and definitions, abbreviations and conventions 14
3.1 Terms and definitions 14
3.2 Abbreviations 21
3.3 Conventions 22
3.3.1 General 22
3.3.2 Precedence 22
3.3.3 Lists 23
3.3.4 Keywords 23
3.3.5 Numbering 24
3.3.6 Signal conventions 24
3.3.7 Bit conventions 24
3.3.8 State diagram conventions 24
3.3.9 Timing conventions 25
3.3.10 Byte ordering for data transfers 26
4 General operational requirements 28
5 I/O register descriptions 28
6 Command descriptions 28
7 Parallel interface physical and electrical requirements 28
8 Parallel interface signal assignments and descriptions 28
9 Parallel interface general operating requirements of the physical, data link, and transport layers 28
10 Parallel interface register addressing 28
11 Parallel interface transport protocols 29
12 Parallel interface timing 29
13 Serial interface general overview 29
13.1 Overview 29
13.2 Sub-module operation 30
13.3 Parallel ATA emulation 31
13.3.1 General 31
13.3.2 Software reset 32
13.3.3 Device 0-only emulation 32
13.3.4 Device 0/Device 1 emulation (optional) 33
14 Serial interface physical layer 34
14.1 Overview 34
14.1.1 General 34
14.1.2 List of services 34
14.2 Connectors specifications 35
14.2.1 Overview 35
14.2.2 General descriptions 35
14.2.3 Connector drawings 37
14.2.4 Connector pinouts 44

14.2.5 Backplane connector configuration and blind-mating tolerance 45
14.2.6 Connector locations 45
14.2.7 Connector conformance requirements 49
14.3 Cable assemblies 55
14.4 Phy (physical layer electronics) 56
14.4.1 Physical plant as a system 56
14.4.2 Bit error rate testing 60
14.4.3 Frame error rate testing 61
14.4.4 Test requirements, non-compliant patterns 62
14.4.5 Test requirements, compliant frame patterns 62
14.4.6 Test requirements, loopback 62
14.4.7 Test Method for Data Rate Frequency Variation, SSC Profile 63
14.4.8 Block diagram 63
14.4.9 Electrical specifications 65
14.4.10 Frame error-rate measurements 68
14.4.11 Receiver Differential voltage 68
14.4.12 Receiver Common-mode voltage 68
14.4.13 Transmitter Differential voltage 68
14.4.14 Transmitter Common-mode voltage 68
14.4.15 Rise/fall times 68
14.5 Electrical features 69
14.5.1 Definitions 69
14.5.2 Differential voltage/timing (EYE) diagram 70
14.5.3 Spread spectrum clocking (SSC) 73
14.5.4 Common-mode biasing 75
14.5.5 Matching 75
14.5.6 Out of band signalling 76
14.6 Elasticity buffer management 94
14.7 BIST (Built in self test) 94
14.7.1 General 94
14.7.2 Loopback testing 94
15 Serial interface Link layer 97
15.1 Overview 97
15.1.1 General 97
15.1.2 Frame transmission 97
15.1.3 Frame receipt 97
15.2 Encoding method 98
15.2.1 General 98
15.2.2 Notation and conventions 98
15.2.3 Character code 99
15.2.4 Transmission summary 106
15.2.5 Reception 107
15.3 Transmission method 108
15.4 Primitives 109
15.4.1 Overview 109
15.4.2 Primitive descriptions 110
15.4.3 Primitive encoding 111
15.4.4 ALIGN primitive 111
15.4.5 CONT primitive 112

15.4.6 DMAT primitive ... 113
15.4.7 EOF primitive ... 114
15.4.8 HOLD/HOLDA primitives ... 114
15.4.9 PMREQ_P, PMREQ_S, PMACK, and PMNAK primitives ... 116
15.4.10 R_ERR primitive ... 116
15.4.11 R_IP primitive ... 116
15.4.12 R_OK primitive ... 116
15.4.13 R_RDY primitive ... 116
15.4.14 SOF primitive ... 116
15.4.15 SYNC primitive ... 116
15.4.16 WTRM primitive ... 116
15.4.17 X_RDY primitive ... 116
15.4.18 Examples ... 116
15.5 CRC calculation ... 120
15.6 Scrambling ... 121
15.6.1 Frame content scrambling ... 121
15.6.2 Repeated primitive suppression ... 121
15.6.3 Link layer state diagrams ... 121
Serial interface Transport layer ... 139
16.1 Transport layer overview ... 139
16.1.1 General ... 139
16.1.2 FIS construction ... 139
16.1.3 FIS decomposition ... 139
16.2 Frame Information Structure (FIS) ... 139
16.2.1 Overview ... 139
16.2.2 Payload content ... 139
16.2.3 FIS types ... 140
16.2.4 Register, Device to Host ... 141
16.2.5 Set Device Bits - Device to Host ... 143
16.2.6 DMA Activate, Device to Host ... 144
16.2.7 First Party DMA Setup, Device to Host or Host to Device (bidirectional) ... 145
16.2.8 BIST Activate, bidirectional ... 146
16.2.9 PIO Setup, Device to Host ... 148
16.2.10 Data, Host to Device or Device to Host (bidirectional) ... 150
16.3 Host transport states ... 151
16.3.1 Host transport idle state diagram ... 151
16.3.2 Host Transport transmit command FIS diagram ... 153
16.3.3 Host Transport transmit control FIS diagram ... 154
16.3.4 Host Transport transmit First Party DMA Setup, Device to Host or Host to Device FIS state diagram ... 155
16.3.5 Host Transport transmit BIST Activate FIS ... 156
16.3.6 Host Transport decompose Register FIS diagram ... 157
16.3.7 Host Transport decompose a Set Device Bits FIS state diagram ... 158
16.3.8 Host Transport decompose a DMA Activate FIS diagram and DMA Data Transfer ... 158
16.3.9 Host Transport decompose a PIO Setup FIS state diagram ... 161
16.3.10 Host Transport decompose a First Party DMA Setup FIS state diagram ... 164
16.3.11 Host transport decompose a BIST Activate FIS state diagram ... 165

16.4 Device transport states 167
16.4.1 Device transport idle state diagram 167
16.4.2 Device Transport send Register, Device to Host state diagram 168
16.4.3 Device Transport send Set Device Bits FIS state diagram 169
16.4.4 Device Transport transmit PIO Setup, Device to Host FIS state diagram 170
16.4.5 Device Transport transmit DMA Activate FIS state diagram 170
16.4.6 Device Transport transmit First Party DMA Setup, Device to Host FIS state diagram 171
16.4.7 Device Transport transmit Data, Device to Host FIS diagram 172
16.4.8 Device Transport transmit BIST Activate FIS diagram 174
16.4.9 Device Transport decompose Register, Host to Device state diagram 176
16.4.10 Device Transport decompose Data (Host to Device) FIS state diagram 177
16.4.11 Device Transport decompose First Party DMA Setup FIS, Host to Device or Device to Host state diagram 178
16.4.12 Device Transport decompose a BIST Activate FIS state diagram 179
17 Serial interface Device Command Layer Protocol 180
17.1 COMRESET or SRST sent by Host 180
17.2 Power-on and COMRESET protocol diagram 180
17.3 Device Idle protocol 182
17.4 Software reset protocol 185
17.5 EXECUTE DEVICE DIAGNOSTIC command protocol 187
17.6 DEVICE RESET command protocol 188
17.7 Non-data command protocol 188
17.8 PIO data-in command protocol 189
17.9 PIO data-out command protocol 190
17.10 DMA data-in command protocol 192
17.11 DMA data out command protocol 193
17.12 PACKET protocol 195
17.13 READ DMA QUEUED command protocol 200
17.14 WRITE DMA QUEUED command protocol 201
18 Host command layer state diagram 204
18.1 Overview 204
18.2 Device Emulation of nIEN with Interrupt Pending 207
19 Serial interface host adapter register interface 208
19.1 Overview 208
19.2 SStatus, SError and SControl registers 209
19.2.1 General 209
19.2.2 SStatus register 209
19.2.3 SError register 210
19.2.4 SControl register 211
20 Serial interface error handling 212
20.1 Architecture 212
20.2 Phy error handling overview 213
20.2.1 Error detection 213
20.2.2 Error control actions 214
20.2.3 Error reporting 214

20.3 Link error handling overview 214
20.3.1 Error detection 214
20.3.2 Error control actions 215
20.3.3 Error reporting 216
20.4 Transport error handling 216
20.4.1 Overview 216
20.4.2 Error detection 216
20.4.3 Error control actions 217
20.4.4 Error reporting 218
20.5 Software error handling overview 218
20.5.1 General 218
20.5.2 Error detection 218
20.5.3 Error control actions 219
Annex A (informative) Command Set summary 220
Annex B (informative) Design and programming considerations for large physical sector devices 220
Annex C (informative) Device determination of cable type 220
Annex D (informative) Signal integrity and UDMA guide 220
Annex E (informative) Register selection address summary 220
Annex F (informative) SAMPLE code for Serial CRC Scrambling 221
F.1 CRC calculation 221
F.1.1 Overview 221
F.1.2 Maximum frame size 221
F.1.3 Example code for CRC algorithm 221
F.1.4 Example CRC implementation output 224
F.2 Scrambling calculation 224
F.2.1 Overview 224
F.2.2 Example code for scrambling algorithm 224
F.2.3 Example scrambler implementation 227
F.3 Example frame 228
Annex G (ínformative) FIS Type field value selection 229
G.1 Overview 229
G.2 Type field values 229
Annex H (informative) Physical Layer implementation examples 230
H.1 Cable construction example 230
H.2 Contact material and plating 231
H.3 Relationship of frequency to the jitter specification 231
H.4 Sampling BER and jitter formulas 232
H.5 DC and AC coupled transmitter examples 233
H.6 OOB signal and squelch detector examples 235
Annex I (informative) Command Processing example 238
I.1 Non-data commands 238
I.1.1 General 238
I.1.2 Legacy DMA read by host from device 238
I.1.3 Legacy DMA write by host to device 238
I.1.4 PIO data read from the device 239

I.1.5 PIO data write to the device 239
I.1.6 READ DMA QUEUED example 240
I.1.7 WRITE DMA QUEUED example 241
I.1.8 ATAPI PACKET commands with PIO data-in 241
I.1.9 ATAPI PACKET commands with PIO data out 242
I.1.10 ATAPI PACKET commands with DMA data-in 243
I.1.11 ATAPI PACKET commands with DMA data-out 244
I.1.12 First Party DMA read of host memory by device 245
I.1.13 First Party DMA write of host memory by device 245
I.2 Odd word count considerations 245
I.2.1 General 245
I.2.2 Legacy DMA read from target for odd word count 246
I.2.3 Legacy DMA write by host to target for odd word count 246
I.2.4 PIO data read from the device 246
I.2.5 PIO data write to the device 247
I.2.6 First Party DMA read of host memory by device 247
I.2.7 First Party DMA write of host memory by device 247
Bibliography 249

Figure 1 – ATA document relationships 13
Figure 2 – State diagram convention 25
Figure 3 – Byte, word and DWORD relationships 28
Figure 4 – Standard ATA device connectivity 29
Figure 5 – The serial implementation of ATA connectivity 30
Figure 6 – Communication layers 31
Figure 7 – Serial implementation connector examples 36
Figure 8 – Device plug connector part 1 of 2 37
Figure 9 – Device plug connector part 2 of 2 38
Figure 10 – Non-Latching Signal Cable receptacle connector interface dimensions 39
Figure 11 – Optional Latching Signal Cable Receptacle connector interface dimensions 40
Figure 12 – Host plug connector interface dimension 41
Figure 13 – Host receptacle connector interface dimensions 42
Figure 14 – Non-Latching Power cable receptacle connector interface dimensions 43
Figure 15 – Optional Latching Power Cable Receptacle 43
Figure 16 – Connector pair blind-mate misalignment tolerance 45
Figure 17 – Device-backplane mating configuration 45
Figure 18 – Device plug connector location on 95 mm (3.5”) device 46
Figure 19 – Device plug connector location on 65 mm (2.5”) device 47
Figure 20 – Recommended host plug spacing for Non-Latching Connectors 48
Figure 21 – Recommended host plug connector clearance and Orientation for Optional Latching Connectors 49
Figure 22 – Signals and grounds assigned in direct connect and cabled 56
Figure 23 – Low transition density pattern 58
Figure 24 – Half-rate / quarter-rate high transition density pattern 58
Figure 25 – Low-frequency spectral content pattern 59
Figure 26 – Simultaneous switching outputs patterns 59

Figure 27 – Composite patterns 60
Figure 28 – Compliant test patterns 62
Figure 29 – Physical plant overall block diagram 64
Figure 30 – Signal rise and fall times 68
Figure 31 – Transmit test fixture 69
Figure 32 – Receive test fixture 69
Figure 33 – Voltage / timing margin base diagram 70
Figure 34 – Jitter output/tolerance mask 71
Figure 35 – Jitter measurement example 73
Figure 36 – Triangular frequency modulation profile 74
Figure 37 – Spectral fundamental frequency comparison 74
Figure 38 – Out of band signals 76
Figure 39 – Host phy initialization state machine (States HP1-HP13) 78
Figure 40 – Device phy initialization state machine (States DP1-DP12) 83
Figure 41 – COMRESET sequence 87
Figure 42 – COMINIT sequence 89
Figure 43 – Power-on sequence 91
Figure 44 – ON to Partial/Slumber, host initiated 92
Figure 45 – ON to Partial/Slumber, device initiated 93
Figure 46 – Loopback, far-end retimed 95
Figure 47 – Loopback, far-end analog 96
Figure 48 – Loopback, near-end analog 97
Figure 49 – Bit designations 98
Figure 50 – Nomenclature reference 99
Figure 51 – Conversion examples 99
Figure 52 – Coding examples 102
Figure 53 – Bit ordering and significance 107
Figure 54 – Single bit error with two character delay 108
Figure 55 – Single bit error with one character delay 108
Figure 56 – Transmission structures 109
Figure 57 – CONT usage example 117
Figure 58 – Link idle state diagram (States L1, LS1-LS3) 122
Figure 59 – Link transmit state diagram (States LT1-LT9) 125
Figure 60 – Link receive state diagram (States LR1-LR9) 131
Figure 61 – Link power mode state diagram (States LPM1-LPM8) 136
Figure 62 – Register, Host to Device FIS layout 140
Figure 63 – Register, Device to Host FIS layout 141
Figure 64 – Set Device Bit, Device to Host FIS layout 143
Figure 65 – DMA Activate, Device to Host FIS layout 144
Figure 66 – First Party DMA Setup – Device to Host FIS layout 145
Figure 67 – BIST Activate, Bidirectional 146
Figure 68 – PIO Setup, Device to Host FIS layout 148
Figure 69 – Data, Host to Device or Device to Host FIS layout 150

Figure 70 – Host transport idle state diagram (States HTI1-HTI2) 151
Figure 71 – Host transport transmit command FIS diagram (States HTCM1-HTCM2) 153
Figure 72 – Host transport transmit control FIS diagram (States HTCR1-HTCR2) 154
Figure 73 – Host transport transmit First Party DMA setup – Device to host or host to device FIS (States HTDMASTUP0-HTDMASTUP1) 155
Figure 74 – Host transport transmit BIST activate FIS (States HTXBIST0-HTXBIST1) 156
Figure 75 – Host transport decompose register FIS diagram (States HTR1- HTR2) 157
Figure 76 – Host transport decompose Set Device Bits FIS state diagram (States HTDB0-HTDB1) 158
Figure 77 – Host transport decompose DMA activate FIS diagram (States HTDA1-HTDA5) 159
Figure 78 – Host transport decompose PIO setup FIS state diagram (States HTPS1-HTPS6) 162
Figure 79 – Host transport decompose First Party DMA Setup FIS state diagram (State HTDS1) 165
Figure 80 – Host transport decompose BIST activate FIS state diagram (State HTRBIST0-HTRBIST1) 166
Figure 81 – Device transport idle state diagram (States DTI0-DTI1) 167
Figure 82 – Device transport send register – Device to host state diagram (DTR0-DTR1) 168
Figure 83 – Device transport send set device bits FIS state diagram (DTDB0-DTDB1) 169
Figure 84 – Device transport transmit PIO setup – Device to Host FIS state diagram (States DTPIOSTUP0-DTPIOSTUP1) 170
Figure 85 – Device transport transmit DMA activate FIS state diagram (States DTDMAACT0-DTDMAACT1) 171
Figure 86 – Device transport transmit First Party DMA setup – Device to Host state diagram (States DTDMASTUP0-DTDMASTUP1) 172
Figure 87 – Device transport transmit data – Device to Host FIS diagram (State DTDATAI0-DTDATAI2) 173
Figure 88 – Device transport transmit BIST activate FIS diagram (States DTXBIST0-DTXBIST1) 175
Figure 89 – Device transport decompose register – Host to Device state diagram (State DTCMD0) 176
Figure 90 – Device transport decompose data (host to device) FIS state diagram (States DTDATAO0-DTDATAO2) 177
Figure 91 – Device transport decompose First Party DMA Setup FIS – Host to Device or device to host state diagram (State DTDMASTUP0) 178
Figure 92 – Device transport decompose BIST activate FIS (States DTRBIST0-DTRBIST1) 179
Figure 93 – Power on and COMRESET protocol (States DHR0-DHR3) 180
Figure 94 – Device idle protocol (States DI0-DI7) 182
Figure 95 – Software reset protocol (States DSR0-DSR3) 185
Figure 96 – EXECUTE DEVICE DIAGNOSTIC command protocol (States DEDD0-DEDD2) 187
Figure 97 – DEVICE RESET command protocol (States DDR0-DDR1) 188
Figure 98 – Non-data command protocol (States DND0-DND1) 188
Figure 99 – PIO data-in command protocol (States DPIOI0-DPIOI3) 189
Figure 100 – PIO data-out command protocol (States DPIOO0-DPIOO3) 190

Figure 101 – DMA data-in command protocol (States DDMAI0-DDMAI1) 192
Figure 102 – DMA data-out command protocol (States DDMAO0-DDMAO3) 193
Figure 103 – PACKET command protocol (States DP0-DP16) 195
Figure 104 – READ DMA QUEUED command protocol (States DDMAQI0-DDMAQI4) 200
Figure 105 – WRITE DMA QUEUED command protocol (DDMAOQ0-DDMAQO5) 202
Figure 106 – Host adapter state diagram (States HA0-HA2) 204
Figure 107 – Error handling architecture 212

Figure H.1 – Cable construction example 230
Figure H.2 – Jitter as a function of frequency 232
Figure H.3 – Sampling bit error rate formulae 233
Figure H.4 – Transmitter example 1 234
Figure H.5 – Transmitter example 2 235
Figure H.6 – OOB signal detector 236
Figure H.7 – Squelch detector 237

Table 1 – PACKET delivered command sets 13
Table 2 – 16-bit Transfer Byte order 27
Table 3 – 8-bit Transfer Byte order 27
Table 4 – Device plug connector pin definition 44
Table 5 – Signal integrity requirements and test procedures 50
Table 6 – Housing and contact electrical parameters, test procedures and requirements 52
Table 7 – Mechanical test procedures and requirements 53
Table 8 – Environmental parameters, test procedures, and requirements 54
Table 9 – Additional requirement 54
Table 10 – Connector test sequences 55
Table 11 – Physical Layer Electrical Requirements 66
Table 12 – Voltage / timing margin definition 71
Table 13 – Sampling differential noise budget 72
Table 14 – Desired peak amplitude reduction by SSC 75
Table 15 – Out of band signal times 76
Table 16 – Interface power states 90
Table 17 – 5b/6b coding 101
Table 18 – 3b/4b coding 101
Table 19 – Valid data characters 103
Table 20 – Valid control characters 106
Table 21 – Description of primitives 110
Table 22 – Primitive encoding 111
Table 23 – Valid CONT Transmission Sequences 112
Table 24 – Latency example 115
Table 25 – SRST write from host to device transmission breaking through a device to host Data FIS 115
Table 26 – Shadow Command Block and Shadow Control Block transmission example 118

Table 27 – Data from host to device transmission example 119
Table 28 – DMA data from host to device, device terminates transmission example 120
Table 29 – SCR definition 209
Table 30 – SCR definition 209

Table F.1 – CRC and scrambler calculation example - PIO Write Command 228

Table G.1 – Type field values 229

Table H.1 – Contact material and plating example 231